

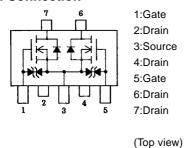
FP402

N-Channel MOS Silicon FET Very High-Speed Switching Applicaitons

Features

- · Low ON resistance.
- · Very high-speed switching.
- · Complex type with 2 low-voltage-drive N-channel MOSFETs facilitating high-density mounting.

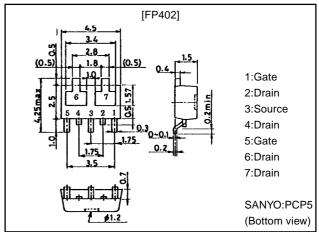
Electrical Connection



Package Dimensions

unit:mm

2102A



Specifications

Absolute Maximum Ratings at Ta = 25°C

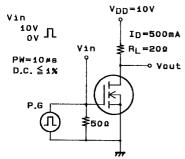
Parameter	Symbol	Conditions	Ratings	Unit
Drain-to-Source Voltage	VDSS		20	V
Gate-to-Source Voltage	VGSS		±15	V
Drain Current (DC)	ID		1	Α
Drain Current (Pulse)	I _{DP}	PW≤10μs, duty cycle ≤1%	4	Α
Allowable Power Dissipation	PD	Tc=25°C, 1 unit	2.0	W
	PD	Mounted on ceramic board (250mm²×0.8mm) 1 unit	0.8	W
Total Power Dissipation	PT	Mounted on ceramic board (250mm²×0.8mm)	1.1	W
Channel Temperature	Tch		150	°C
Storage Temperature	Tstg		-55 to +150	°C

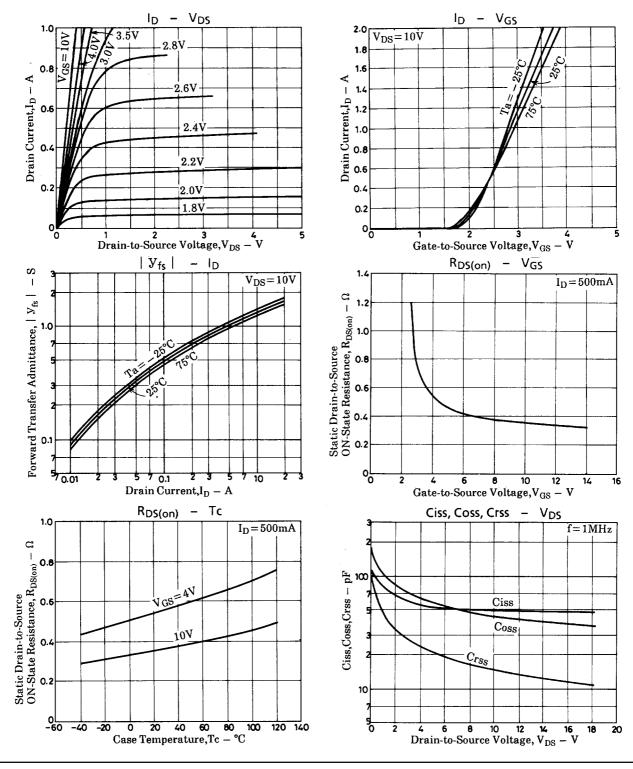
Electrical Characteristics at Ta=25°C

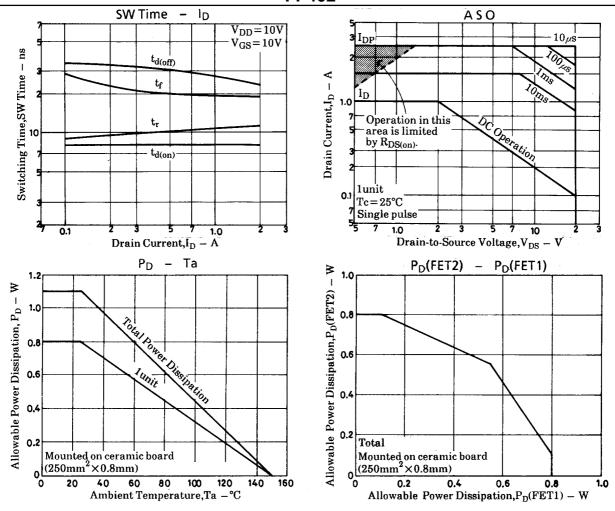
Parameter	Symbol	Conditons		Ratings		
			min	typ	max	Unit
D-S Breakdown Voltage	V(BR)DSS	I _D =1mA, V _{GS} =0	20			V
Zero Gate Voltage Drain Current	IDSS	V _{DS} =20V, V _{GS} =0			100	μA
Gate-to-Source Leakage Current	I _{GSS}	V _{GS} =±12V, V _{DS} =0			±10	μA
Cutoff Voltage	VGS(off)	V _{DS} =10V, I _D =1mA	0.8		2.0	V
Forward Transfer Admittance	Yfs	V _{DS} =10V, I _D =500mA	0.6	1.0		S
Static Drain-to-Source ON-State Resistance	R _{DS(on)}	I _D =500mA, V _{GS} =10V		350	480	mΩ
	R _{DS(on)}	I _D =500mA, V _{GS} =4V		550	750	mΩ
Input Capacitance	Ciss	V _{DS} =10V, f=1MHz		50		pF
Output Capacitance	Coss	V _{DS} =10V, f=1MHz		45		pF
Reverse Transfer Capacitance	Crss	V _{DS} =10V, f=1MHz		15		pF
Turn-ON Delay Time	t _{d(on)}	See specified Test Circuit		8		ns
Rise Time	t _r	See specified Test Circuit		10		ns
Turn-OFF Delay Time	td(off)	See specified Test Circuit		30		ns
Fall Time	t _f	See specified Test Circuit		20		ns
Diode Forward Voltage	V _{SD}	I _S =1A, V _{GS} =0		1.0		V
Blode i erwara veltage	,20	15-174, 165-1		1.0		

Marking:402

Switching Time Test Circuit







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